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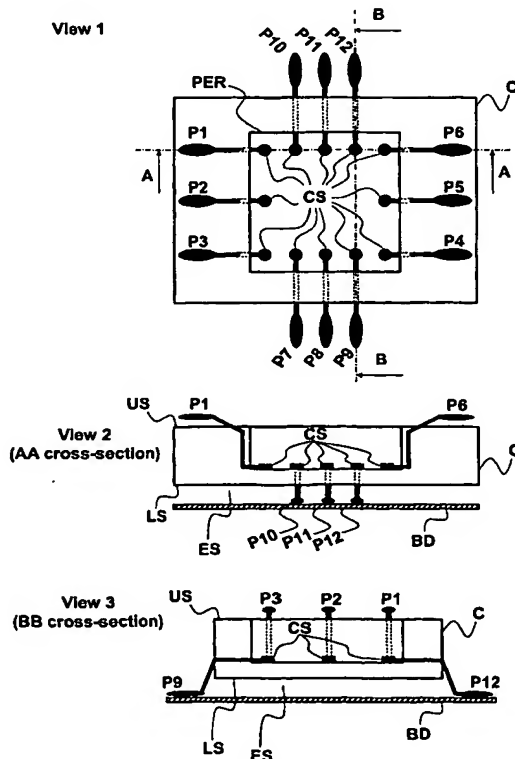
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(54) Title: CONNECTOR FOR CHIP-CARD



(57) Abstract: The invention relates to a connector (C) comprising an upper surface (US) and a lower surface (LS), contact pins (P1-P6) emerging above said upper surface (US) and intended to be in contact with a chip card, contact pins (P7-P12) emerging below said lower surface (LS) and intended to be in contact with a board, a cavity in said upper surface (US) intended to receive a circuit (IC) comprising contact tabs (CT), said cavity comprising contact surfaces (CS) connected to said contact pins and intended to be in contact with said contact tabs (CT).

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